

2339978-7

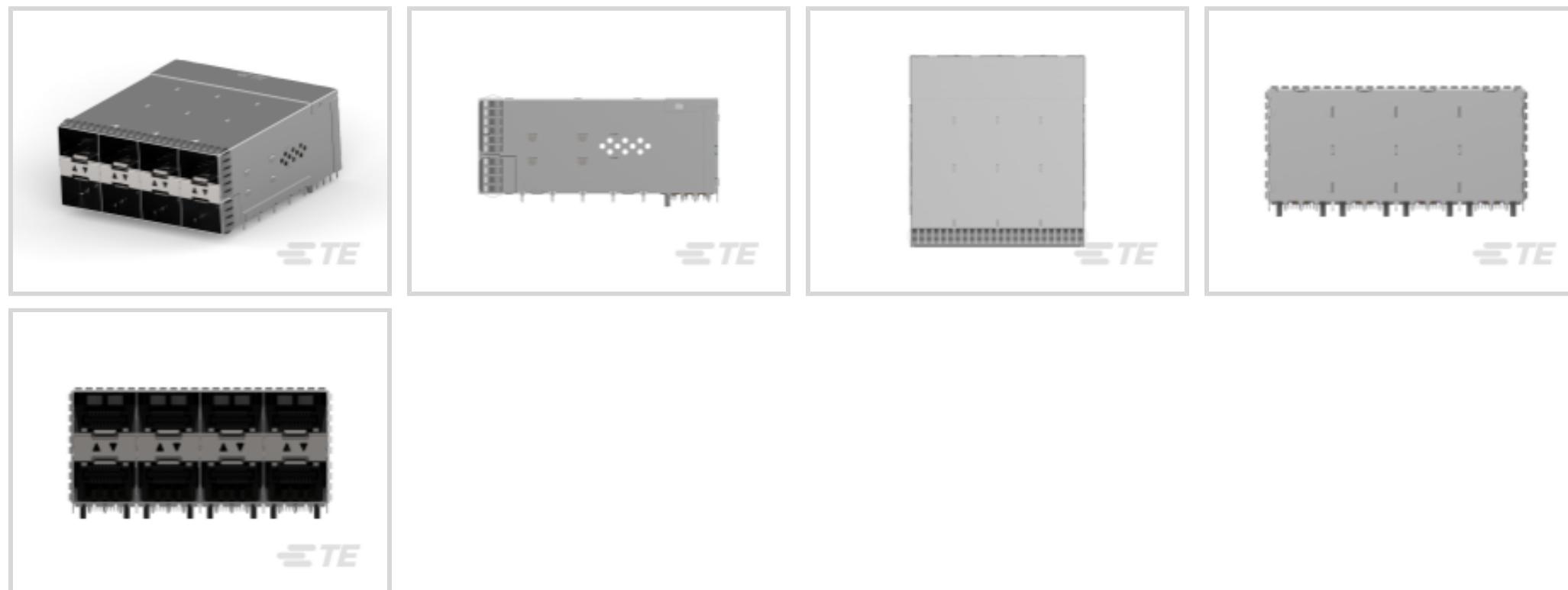
✓ ACTIVE

**SFP56**

TE Internal #: 2339978-7

zSFP+ Stacked (SFP56), Cage Assembly with Integrated Connector,  
.018in [.6mm] Centerline, Signal[View on TE.com >](#)

Connectors &gt; Pluggable I/O Connectors &amp; Cages &gt; SFP56 Stacked Cage Assembly: EMI Spring

Pluggable I/O Product Type: **Cage Assembly with Integrated Connector**Centerline (Pitch): **.6 mm [.018 in]**Circuit Application: **Signal**Operating Temperature Range: **-55 - 105 °C [-67 - 221 °F]**Data Rate (Max): **56 Gb/s**[All SFP56 Stacked Cage Assembly: EMI Spring \(48\)](#)**Features****Product Type Features**

|                            |   |
|----------------------------|---|
| Cage Type                  | Stacked                                 |
| Pluggable I/O Product Type | Cage Assembly with Integrated Connector |
| Form Factor                | zSFP+ Stacked (SFP56)                   |

**Configuration Features**

|                           |       |
|---------------------------|-------|
| Number of Positions       | 20    |
| Number of Ports           | 8     |
| Port Matrix Configuration | 2 x 4 |

**Electrical Characteristics**

|                 |         |
|-----------------|---------|
| Data Rate (Max) | 56 Gb/s |
|-----------------|---------|

**Termination Features**

|   |                          |
|---|--------------------------|
| Termination Method to Printed Circuit Board | Through Hole - Press-Fit |
|---|--------------------------|

**Housing Features**

|                    |                 |
|--------------------|-----------------|
| Centerline (Pitch) | .6 mm [.018 in] |
|--------------------|-----------------|

### Usage Conditions

|                             |                            |
|-----------------------------|----------------------------|
| Operating Temperature Range | -55 - 105 °C[-67 - 221 °F] |
|-----------------------------|----------------------------|

### Operation/Application

|                            |        |
|----------------------------|--------|
| Pluggable I/O Applications | SFP28  |
| Circuit Application        | Signal |

### Other

|                              |                               |
|------------------------------|-------------------------------|
| Included Lightpipe           | Yes                           |
| EMI Containment Feature Type | Internal/External EMI Springs |

### Product Compliance

For compliance documentation, visit the product page on [TE.com](http://TE.com)>

|   |   |
|---|---|
| EU RoHS Directive 2011/65/EU                  | Compliant   |
| EU ELV Directive 2000/53/EC                   | Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JAN 2024<br>(240)<br>Candidate List Declared Against: JAN 2024<br>(240)<br>Does not contain REACH SVHC |
| Halogen Content                               | Low Bromine/Chlorine - Br and Cl < 900<br>ppm per homogenous material. Also BFR<br>/CFR/PVC Free                                    |
| Solder Process Capability                     | Not reviewed for solder process capability  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Compatible Parts



TE Part # 1761394-1  
DUST COVER, SFP, GANGED &  
STACKED

## Also in the Series | **SFP56**



Pluggable I/O Cable Assemblies(17)



Pluggable IO Connectors & Cages(53)

## Customers Also Bought



TE Part # 2007394-6  
SFP+ assy2x4 Spring FingersInnner LP  
Sn



TE Part # 1551920-2  
zQSFP+ connector assembly



TE Part # 1734101-4  
Champ050 series,40pos,Au over PdNi



TE Part # 5052902015  
RNF-100-1/16-2-STK

## Documents

### Product Drawings

#### SFP56 STACKED 2X4 RECEPTACLE ASSEMBLY

English

### CAD Files

#### 3D PDF

3D

#### Customer View Model

[ENG\\_CVM\\_CVM\\_2339978-7\\_A.2d\\_dxf.zip](#)

English

#### Customer View Model

[ENG\\_CVM\\_CVM\\_2339978-7\\_A.3d\\_jgs.zip](#)

English

#### Customer View Model

[ENG\\_CVM\\_CVM\\_2339978-7\\_A.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

## Product Specifications

### Product Specification

English